

Product data sheet

1. General description

Planar passivated very sensitive gate Silicon Controlled Rectifier in a TO92 plastic package.

2. Features and benefits

- High voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Very sensitive gate

3. Applications

- Earth leakage circuit breakers or Ground Fault Circuit Interrupters (GFCI)
- Ignition circuits
- Low power latching circuits
- Protection circuits / shut-down circuits: lighting ballasts
- Protection circuits / shut-down circuits: Switched Mode Power Supplies

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		Conditions		тур	IVIAX	Unit
Absolute	maximum rating					
V_{RRM}	repetitive peak reverse voltage		-	-	800	V
I _{T(AV)}	average on-state current	half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 1</u>	-	-	0.5	A
$I_{T(RMS)}$	RMS on-state current	half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 2;</u> <u>Fig. 3</u>	-	-	0.8	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	-	-	9	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	-	-	10	А
T _j	junction temperature		-	-	125	°C
Static cha	aracteristics		Ċ			
I _{GT}	gate trigger current	$V_{\rm D}$ = 12 V; $I_{\rm T}$ = 10 mA; $T_{\rm j}$ = 25 °C; Fig. 7	15	33	50	μA
Dynamic	characteristics	· · ·	·		·	
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 536 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; \text{ R}_{GK} = 1 \text{ k}\Omega;$ ($V_{DM} = 67\% \text{ of } V_{DRM}$); exponential waveform; Fig. 12	150	-	-	V/µs

5. Pinning information

Table 2. P	inning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	А	anode		
2	G	gate	l line line line line line line line lin	A H K
3	К	cathode	() () () [] [] 3 2 1 TO-92 (SOT54)	G sym037

6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
BT169H	TO92	BT169H-LML	Reel	2000	SOT54 wide pitch	14-Nov-2013		

7. Marking

Table 4. Marking codes						
Type number	Marking codes					
BT169H-L	BT169HL					

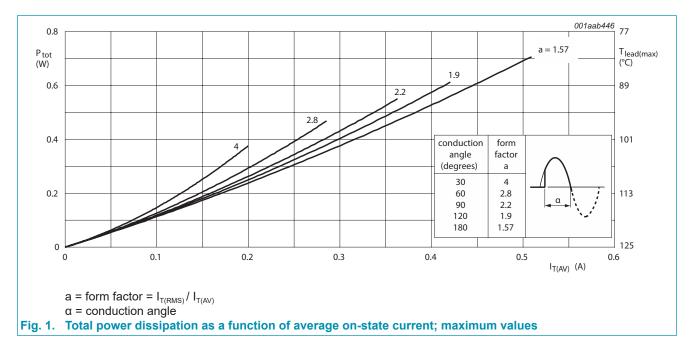
8. Limiting values

Table 5. Limiting values

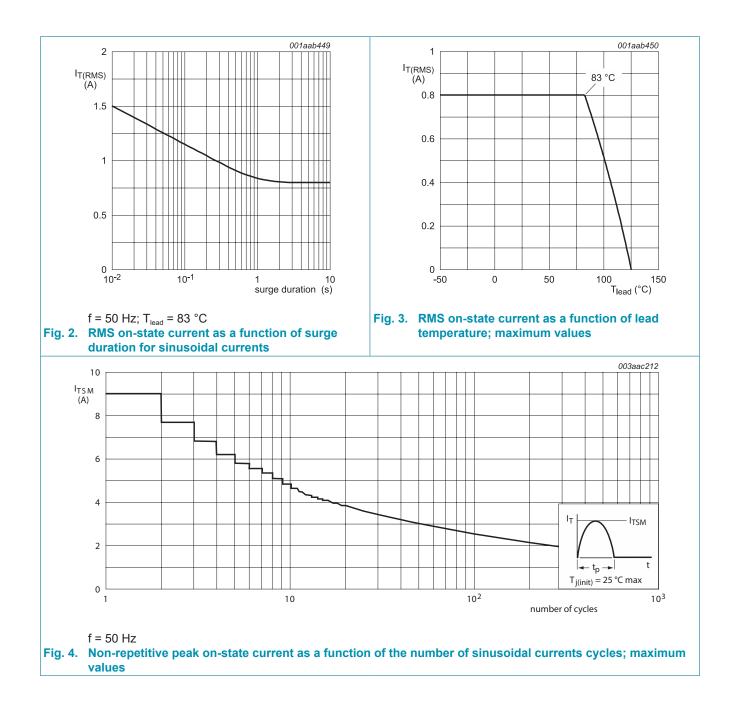
In accordance with the Absolute Maximum Rating System (IEC 60134).

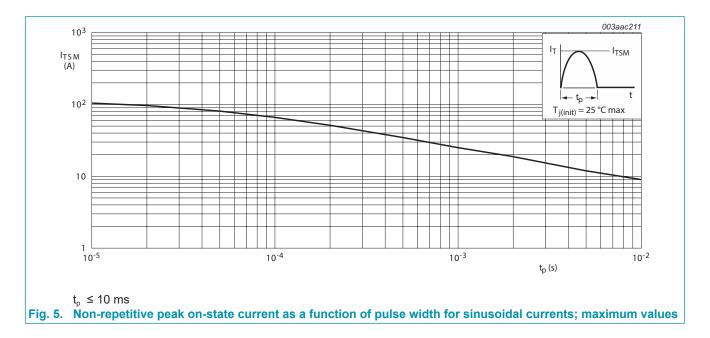
Symbol	Parameter	Conditions		Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage			-	800	V
V _{RRM}	repetitive peak reverse voltage			-	800	V
I _{T(AV)}	average on-state current	half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 1</u>		-	0.5	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 2</u> ; <u>Fig. 3</u>		-	0.8	А
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5		-	9	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms		-	10	А
l ² t	l ² t for fusing	t _p = 10 ms; SIN		-	0.41	A ² s
dl _⊤ /dt	rate of rise of on-state current	$I_T = 2 \text{ A}; I_G = 10 \text{ mA}; \text{dI}_G/\text{dt} = 100 \text{ mA}/\mu\text{s}$		-	50	A/µs
I _{GM}	peak gate current			-	1	А
V_{RGM}	peak reverse gate voltage			-	5	V
P _{GM}	peak gate power			-	2	W
P _{G(AV)}	average gate power	over any 20 ms period		-	0.1	W
T _{stg}	storage temperature			-40	150	°C
Tj	junction temperature		[1]	-	125	°C

[1] Operation above 110°C may require the use of a gate to cathode resistor of $1k\Omega$ or less.



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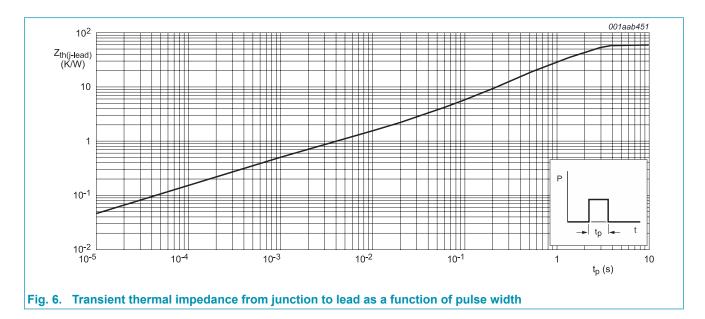




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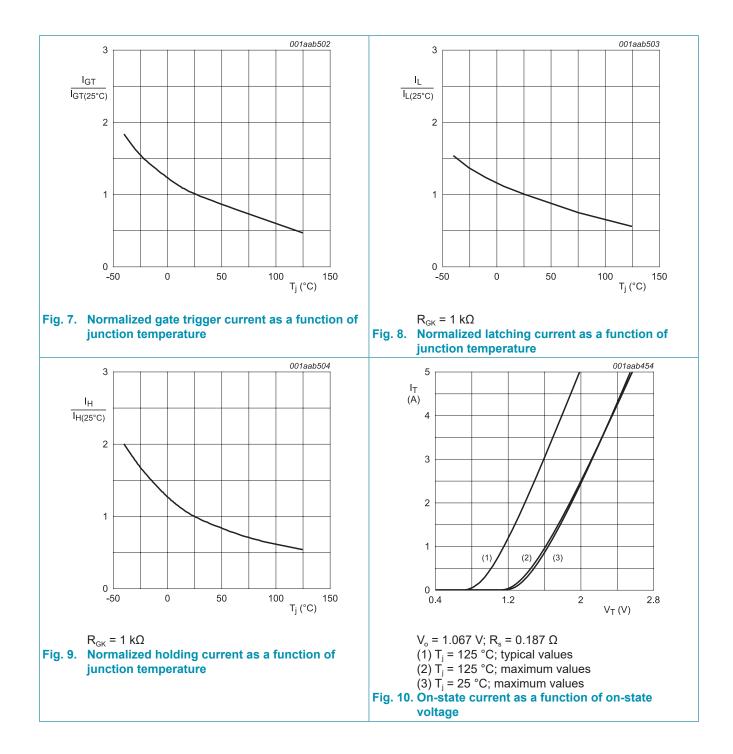
9. Thermal characteristics

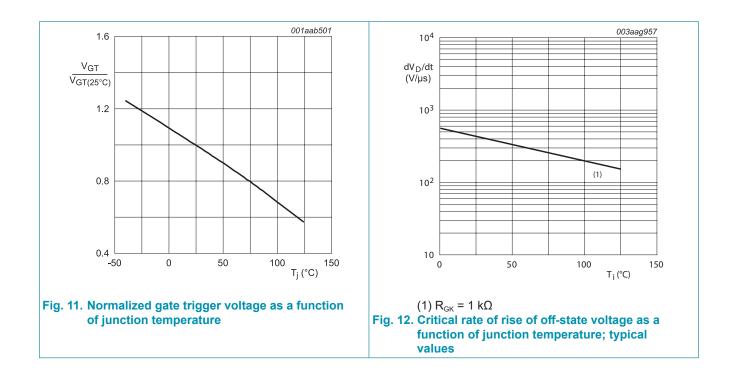
able 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	<u>Fig. 6</u>		-	-	60	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	printed circuit board mounted: lead length = 4 mm		-	150	-	K/W



10. Characteristics

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
I _{GT}	gate trigger current	V _D = 12 V; I _T = 10 mA; T _j = 25 °C; <u>Fig. 7</u>	15	33	50	μA
I _L	latching current	V_{D} = 12 V; I _G = 0.5 mA; T _j = 25 °C; R _{GK(ext)} = 1 kΩ; Fig. 8	-	2	6	mA
I _H	holding current	V_{D} = 12 V; T _j = 25 °C; R _{GK(ext)} = 1 kΩ; Fig. 9	-	1.5	3	mA
V _T	on-state voltage	I _T = 1.2 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.25	1.7	V
V_{GT}	gate trigger voltage	V _D = 12 V; I _T = 10 mA; T _j = 25 °C; Fig. 11	-	0.5	0.8	V
		V _D = 800 V; I _T = 10 mA; T _j = 125 °C	0.3	0.5	-	V
I _D	off-state current	$V_{\rm D}$ = 800 V; $R_{\rm GK(ext)}$ = 1 k Ω ; $T_{\rm j}$ = 125 °C	-	0.05	0.1	mA
I _R	reverse current	V_{R} = 800 V; T _j = 125 °C; R _{GK(ext)} = 1 kΩ	-	0.05	0.1	mA
Dynamic	characteristics					
dV _D /dt	rate of rise of off-state voltage	$ V_{\text{DM}} = 536 \text{ V}; \text{T}_{\text{j}} = 125 ^{\circ}\text{C}; \text{R}_{\text{GK}} = 1 \text{k}\Omega; \\ (\text{V}_{\text{DM}} = 67\% \text{ of } \text{V}_{\text{DRM}}); \text{ exponential} \\ \text{waveform; } \overline{\text{Fig. 12}} $	150	-	-	V/µs
t _{gt}	gate-controlled turn-on time	$I_{TM} = 2 \text{ A}; V_D = 800 \text{ V}; I_G = 10 \text{ mA}; \text{ d}I_G/$ dt = 0.1 A/µs; T _j = 25 °C	-	2	-	μs
t _q	commutated turn-off time		-	100	-	μs

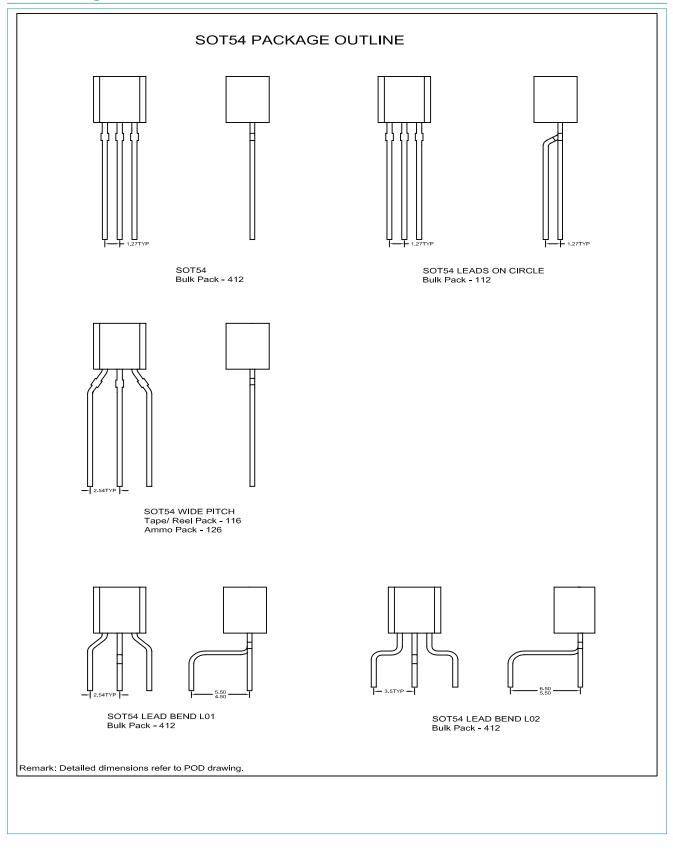


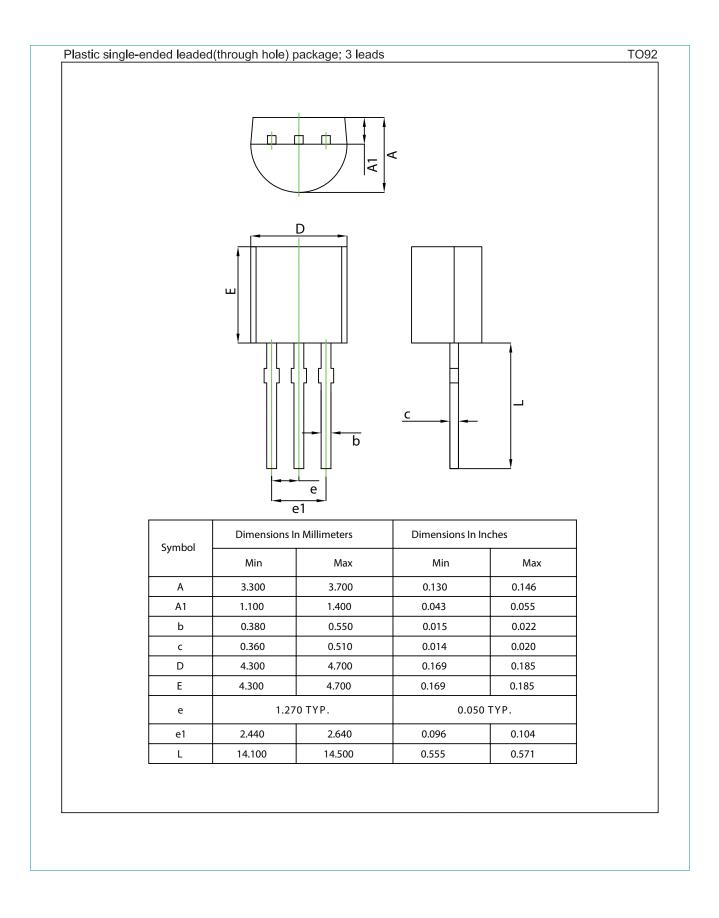


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11. Package outline





Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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